

EMIF10-LCD01C1

10 LINES EMI FILTER AND ESD PROTECTION

IPAD™

MAIN PRODUCT CHARACTERISTICS:

Where EMI filtering in ESD sensitive equipment is required:

- LCD for Mobile phones
- Computers and printers
- Communication systems
- MCU Boards

DESCRIPTION

The EMIF10-LCD01C1 is a 10 lines highly integrated devices designed to suppress EMI/RFI noise in all systems subjected to electromagnetic interferences. The EMIF10 flip chip packaging means the package size is equal to the die size. This filter includes an ESD protection circuitry, which prevents the device from destruction when subjected to ESD surges up 15kV.

BENEFITS

- EMI symmetrical (I/O) low-pass filter
- High efficiency in EMI filtering
- Very low PCB space consuming: < 7mm²
- Coating resin on back side
- Very thin package: 0.69 mm
- High efficiency in ESD suppression on input pins (IEC61000-4-2 level 4)
- High reliability offered by monolithic integration
- High reducing of parasitic elements through integration and wafer level packaging.

COMPLIES WITH THE FOLLOWING STANDARDS: IEC61000-4-2:

Level 4 input pins 15kV (air discharge)

8kV (contact discharge)

Level 1 output pins 2kV (air discharge)

2kV (contact discharge)

MIL STD 833E - Method 3015-6 Class 3

Table 1: Order Code

Part Number	Marking
EMIF10-LCD01C1	FL

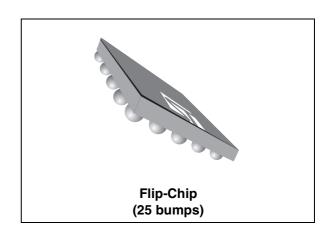


Figure 1: Pin Configuration (ball side)

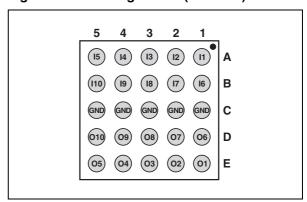


Figure 2: Basic Cell Configuration

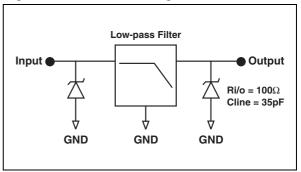
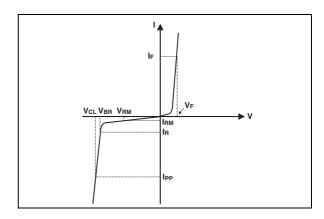


Table 2: Absolute Maximum Ratings $(T_{amb} = 25^{\circ}C)$

Symbol	Parameter	Value	Unit
T _j	Junction temperature	125	°C
T _{op}	Operating temperature range	-40 to + 85	°C
T _{stg}	Storage temperature range	-55 to +150	°C

Table 3: Electrical Characteristics $(T_{amb} = 25^{\circ}C)$

Symbol	Parameter		
V _{BR}	Breakdown voltage		
I _{RM}	Leakage current @ V _{RM}		
V _{RM}	Stand-off voltage		
V _{CL}	Clamping voltage		
Rd	Dynamic resistance		
I _{PP}	Peak pulse current		
R _{I/O}	Series resistance between Input & Output		
Cline	Input capacitance per line		



Symbol	Test conditions	Min.	Тур.	Max.	Unit
V_{BR}	I _R = 1 mA	6	8	10	V
I _{RM}	V _{RM} = 3V			500	nA
R _{I/O}		90	100	110	Ω
Cline	@ 0V bias		47		pF
Rt / Ft	Induced rise and fall time 10-90% at 26 MHz frequency signal V = 1.9 V (Rt / Ft input 1 ns, 50Ω impedance generator)		8 (1)		ns

⁽¹⁾ guaranteed by design

Figure 3: S21(dB) all lines attenuation measurement and Aplac simulation

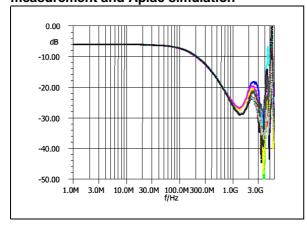
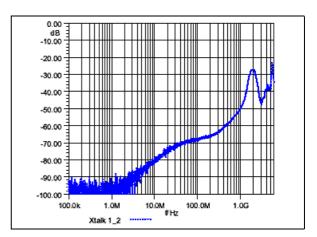


Figure 4: Analog cross talk measurements



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Figure 5: ESD response to IEC61000-4-2 (+15kV air discharge) on one input and on one output

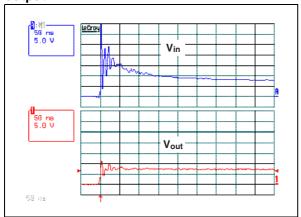


Figure 7: Line capacitance versus applied voltage

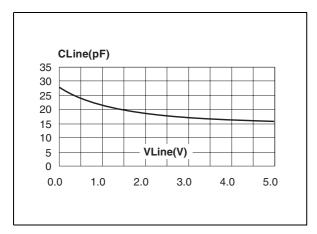


Figure 9: Fall time 10-90% measurements with 1.9V signal at 26 MHz frequency (50 Ω generator)

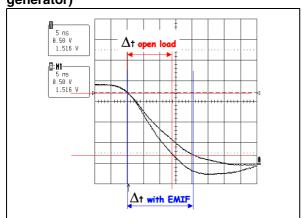


Figure 6: ESD response to IEC61000-4-2 (-15kV air discharge) on one input and on one output

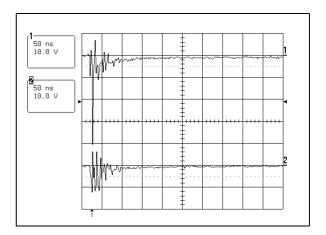


Figure 8: Rise time 10-90% measurements with 1.9V signal at 26 MHz frequency (50 Ω generator)

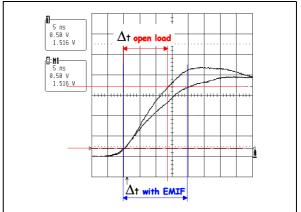


Figure 10: Aplac model

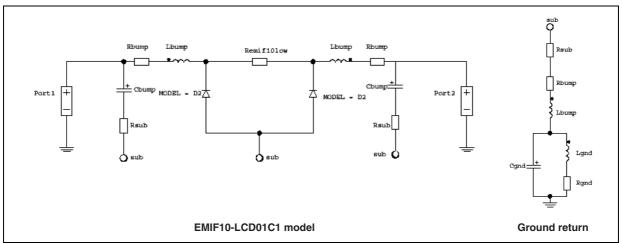


Figure 11: Aplac parameters

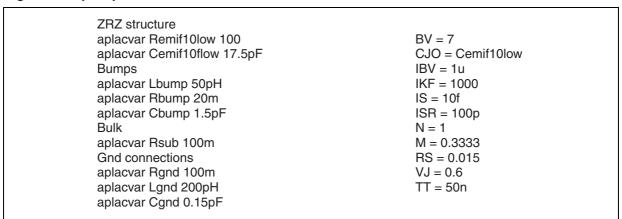
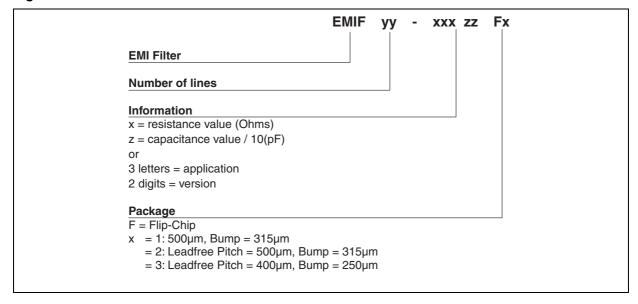


Figure 12: Order Code



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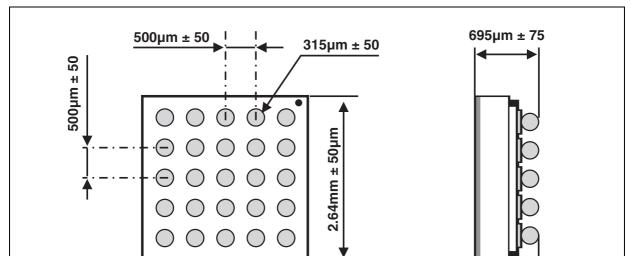
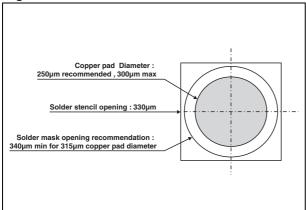


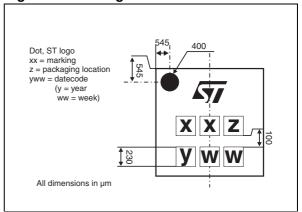
Figure 13: FLIP-CHIP Package Mechanical Data

Figure 14: Foot Print Recommendations



2.64mm ± 50 μ m

Figure 15: Marking



 $250\mu m \pm 40$

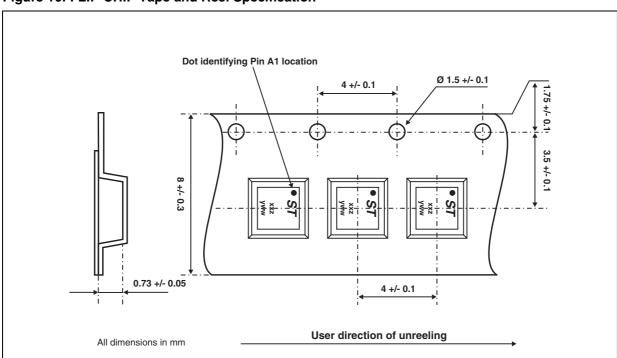


Figure 16: FLIP-CHIP Tape and Reel Specification

Table 4: Ordering Information

Part Number	Marking	Package	Weight	Base qty	Delivery mode
EMIF10-LCD01C1	FL	Flip-Chip	9.3 mg	5000	Tape & reel (7")

Note: Further packing information available in the application notes

Table 5: Revision History

Date	Revision	Description of Changes
Sep-2004	1	First issue

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⁻ AN1235: "Flip-Chip: Package description and recommandations for use"
- AN1751: "EMI Filters: Recommendations and measurements"

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